

Title (en)

PLATING SOLUTION FOR ELECTROLESS COPPER PLATING

Title (de)

ABSCHIEDUNGSLÖSUNG FÜR DIE STROMLOSE ABSCHIEDUNG VON KUPFER

Title (fr)

SOLUTION DE PLACAGE POUR CUIVRAGE AUTOCATALYTIQUE

Publication

**EP 1681371 A4 20080709 (EN)**

Application

**EP 04771328 A 20040730**

Priority

- JP 2004011327 W 20040730
- JP 2003357992 A 20031017

Abstract (en)

[origin: EP1681371A1] To provide an electroless copper plating solution that is favorable to improve the adhesion of a plating film, and an electroless copper plating solution which realizes uniform plating at a low temperature. This electroless copper plating solution is characterized by containing a water-soluble nitrogen-containing polymer in an electroless copper plating solution, and preferably the above-mentioned electroless copper plating solution contains glyoxylic acid and phosphinic acid as reducing agents. The water-soluble nitrogen-containing polymer is preferably a polyacrylamide or a polyethyleneimine, and preferably its weight average molecular weight (Mw) is at least 100,000, and Mw/Mn is 10.0 or less.

IPC 8 full level

**C23C 18/40** (2006.01); **C23C 18/16** (2006.01)

CPC (source: EP KR US)

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Citation (search report)

- No further relevant documents disclosed
- See references of WO 2005038086A1

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DE FR GB

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JP 4293622 B2 20090708; JP WO2005038086 A1 20061228; KR 100767942 B1 20071017; KR 20060096053 A 20060905;  
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